

SN54AHCT16245, SN74AHCT16245 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCLS335J – MARCH 1996 – REVISED OCTOBER 2000

- Members of Texas Instruments' Widebus™ Family
- Inputs Are TTL-Voltage Compatible
- Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 250 mA Per JESD 17

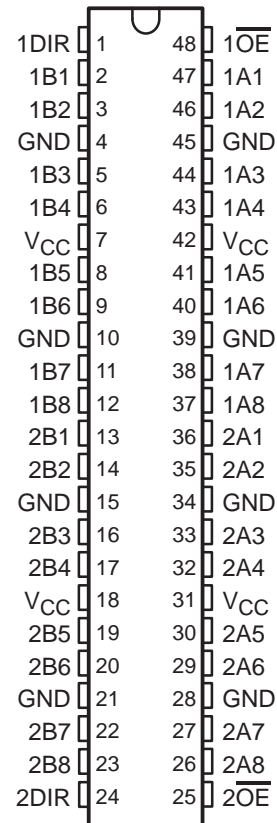
description

The 'AHCT16245 devices are 16-bit (dual-octal) noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

These devices can be used as two 8-bit transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54AHCT16245 . . . WD PACKAGE
SN74AHCT16245 . . . DGG, DGV, OR DL PACKAGE
(TOP VIEW)



ORDERING INFORMATION

| T _A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|---------------|-----------------------|------------------|
| -40°C to 85°C | SSOP – DL | Tube | SN74AHCT16245DL | AHCT16245 |
| | | Tape and reel | SN74AHCT16245DLR | |
| | TSSOP – DGG | Tape and reel | SN74AHCT16245DGGR | AHCT16245 |
| | TVSOP – DGV | Tape and reel | SN74AHCT16245DGVR | HF245 |
| -55°C to 125°C | CFP – WD | Tube | SNJ54AHCT16245WD | SNJ54AHCT16245WD |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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 **TEXAS
INSTRUMENTS**

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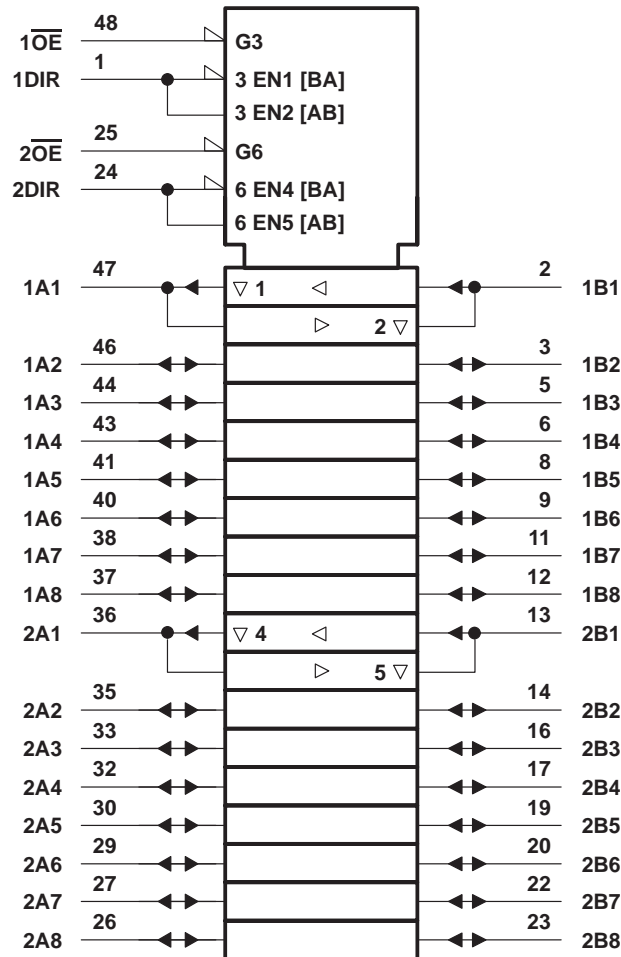
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FUNCTION TABLE
(each 8-bit transceiver)

| INPUTS | | OPERATION |
|-----------------|-----|-----------------|
| \overline{OE} | DIR | |
| L | L | B data to A bus |
| L | H | A data to B bus |
| H | X | Isolation |

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | T _A = 25°C | | | SN54AHCT16245 | | SN74AHCT16245 | | UNIT |
|--------------------|-------------------------------|------------------------------------------------------------------|-----------------------|-----|------|---------------|------|---------------|-----|------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| V _{OH} | I _{OH} = -50 μA | 4.5 V | 4.4 | 4.5 | | 4.4 | | 4.4 | V | |
| | I _{OH} = -8 mA | | 3.94 | | | 3.8 | | 3.8 | | |
| V _{OL} | I _{OL} = 50 μA | 4.5 V | | | 0.1 | | | 0.1 | V | |
| | I _{OL} = 8 mA | | | | 0.36 | | 0.44 | 0.44 | | |
| I _I | $\overline{\text{OE}}$ or DIR | V _I = V _{CC} or GND | 0 V to 5.5 V | | | ±0.1 | | ±1* | | μA |
| I _{OZ} † | A or B inputs | V _O = V _{CC} or GND | 5.5 V | | | ±0.25 | | ±2.5 | | μA |
| I _{CC} | | V _I = V _{CC} or GND, I _O = 0 | 5.5 V | | | 4 | | 40 | | μA |
| ΔI _{CC} ‡ | | One input at 3.4 V, Other inputs at V _{CC} or GND | 5.5 V | | | 1.35 | | 1.5 | | mA |
| C _i | $\overline{\text{OE}}$ or DIR | V _I = V _{CC} or GND | 5 V | | | 2.5 | | 10 | | pF |
| C _{io} | A or B inputs | V _I = V _{CC} or GND | 5 V | | | 4 | | | | pF |

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

† For I/O ports, the parameter I_{OZ} includes the input leakage current.

‡ This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | T _A = 25°C | | | SN54AHCT16245 | | SN74AHCT16245 | | UNIT |
|--------------------|------------------------|-------------|------------------------|-----------------------|-------|------|---------------|------|---------------|------|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | A or B | B or A | C _L = 15 pF | 4.5** | 8.5** | | 1** | 10** | 1 | 9.5 | ns |
| t _{PHL} | | | | 4.5** | 8.5** | 1** | 10** | 1 | 9.5 | | |
| t _{PZH} | $\overline{\text{OE}}$ | A or B | C _L = 15 pF | 8.9** | 13** | | 1** | 14** | 1 | 14 | ns |
| t _{PZL} | | | | 8.9** | 13** | 1** | 14** | 1 | 14 | | |
| t _{PHZ} | $\overline{\text{OE}}$ | A or B | C _L = 15 pF | 9.2** | 14** | | 1** | 15** | 1 | 15 | ns |
| t _{PLZ} | | | | 9.2** | 14** | 1** | 15** | 1 | 15 | | |
| t _{PLH} | A or B | B or A | C _L = 50 pF | 7 | 9.5 | | 1 | 11 | 1 | 10.5 | ns |
| t _{PHL} | | | | 5.3 | 9.5 | 1 | 11 | 1 | 10.5 | | |
| t _{PZH} | $\overline{\text{OE}}$ | A or B | C _L = 50 pF | 8.3 | 14 | | 1 | 15 | 1 | 15 | ns |
| t _{PZL} | | | | 8.3 | 14 | 1 | 15 | 1 | 15 | | |
| t _{PHZ} | $\overline{\text{OE}}$ | A or B | C _L = 50 pF | 8 | 14 | | 1 | 15 | 1 | 15 | ns |
| t _{PLZ} | | | | 8 | 14 | 1 | 15 | 1 | 15 | | |
| t _{sk(o)} | | | C _L = 50 pF | | | 1*** | | | | 1 | ns |

** On products compliant to MIL-PRF-38535, this parameter is not production tested.

*** On products compliant to MIL-PRF-38535, this parameter does not apply.

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16-BIT BUS TRANSCEIVERS
WITH 3-STATE OUTPUTS

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noise characteristics, $V_{CC} = 5\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 4)

| PARAMETER | SN74AHCT16245 | | | UNIT |
|----------------------------------------------------|---------------|------|-----|------|
| | MIN | TYP | MAX | |
| $V_{OL(P)}$ Quiet output, maximum dynamic V_{OL} | | 0.6 | | V |
| $V_{OL(V)}$ Quiet output, minimum dynamic V_{OL} | | -0.6 | | V |
| $V_{OH(V)}$ Quiet output, minimum dynamic V_{OH} | | 4.8 | | V |
| $V_{IH(D)}$ High-level dynamic input voltage | 2 | | | V |
| $V_{IL(D)}$ Low-level dynamic input voltage | | | 0.8 | V |

NOTE 4: Characteristics are for surface-mount packages only.

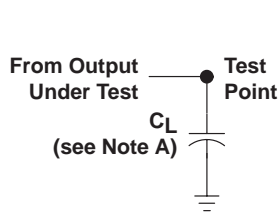
operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

| PARAMETER | TEST CONDITIONS | TYP | UNIT |
|----------------------------------------|-----------------------------|-----|------|
| C_{pd} Power dissipation capacitance | No load, $f = 1\text{ MHz}$ | 17 | pF |

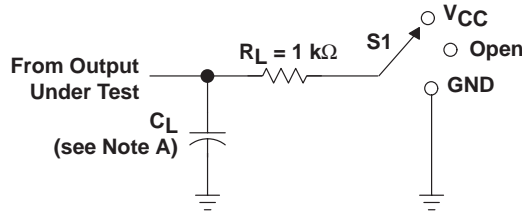
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PARAMETER MEASUREMENT INFORMATION

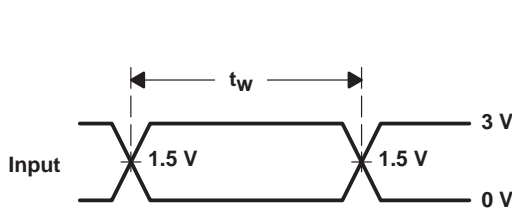


LOAD CIRCUIT FOR
TOTEM-POLE OUTPUTS

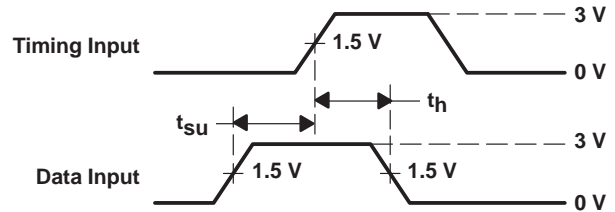


LOAD CIRCUIT FOR
3-STATE AND OPEN-DRAIN OUTPUTS

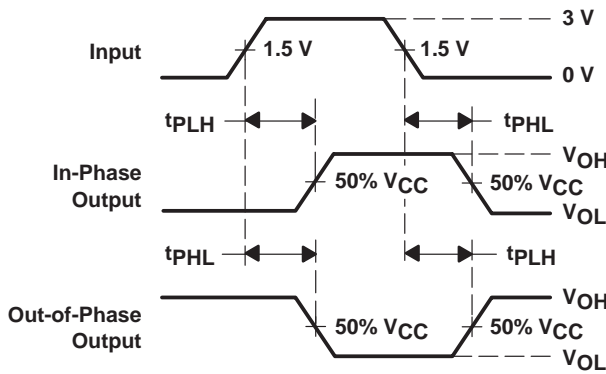
| TEST | S1 |
|-------------------|----------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | V_{CC} |
| t_{PHZ}/t_{PZH} | GND |
| Open Drain | V_{CC} |



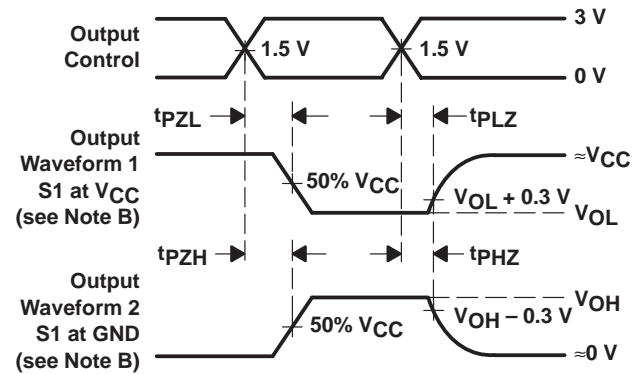
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|-------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74AHCT16245DGGRE4 | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AHCT16245DGGRG4 | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AHCT16245DGVRE4 | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AHCT16245DGVRG4 | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AHCT16245DLRG4 | ACTIVE | SSOP | DL | 48 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT16245DGGR | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT16245DGVR | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT16245DL | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT16245DLG4 | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHCT16245DLR | ACTIVE | SSOP | DL | 48 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AHCT16245DGGR | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 15.8 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74AHCT16245DGVR | TVSOP | DGV | 48 | 2000 | 330.0 | 24.4 | 6.8 | 10.1 | 1.6 | 12.0 | 24.0 | Q1 |
| SN74AHCT16245DLR | SSOP | DL | 48 | 1000 | 330.0 | 32.4 | 11.35 | 16.2 | 3.1 | 16.0 | 32.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AHCT16245DGGR | TSSOP | DGG | 48 | 2000 | 346.0 | 346.0 | 41.0 |
| SN74AHCT16245DGVR | TVSOP | DGV | 48 | 2000 | 346.0 | 346.0 | 41.0 |
| SN74AHCT16245DLR | SSOP | DL | 48 | 1000 | 346.0 | 346.0 | 49.0 |

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

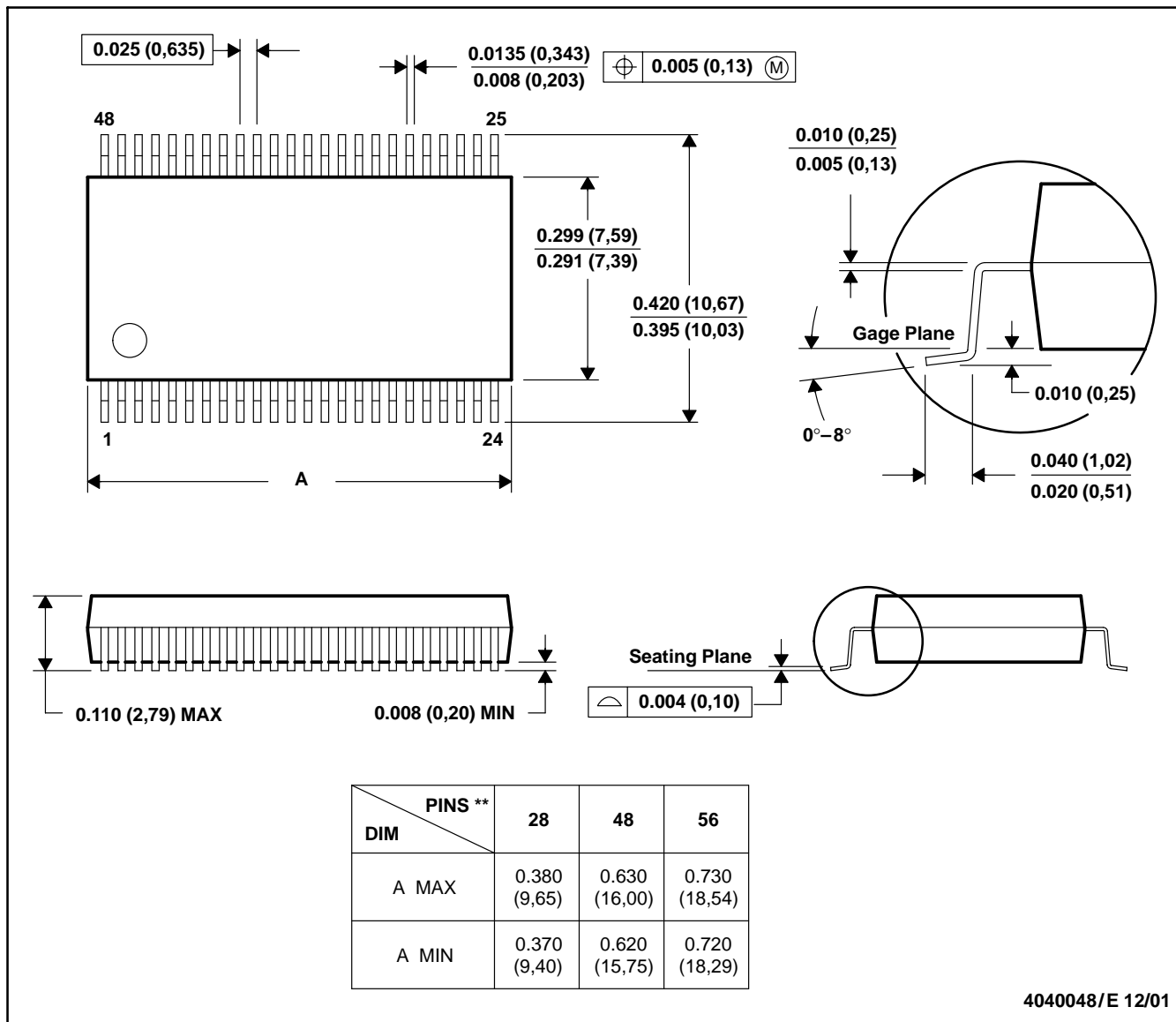


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

DL (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MO-118

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

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